



**SANYO Semiconductors**

# DATA SHEET

**LC863448B, LC863440B  
LC863432B, LC863428B  
LC863424B, LC863420B  
LC863416B**

**CMOS IC  
FROM 48K/40K/32K/28K/24K/20K/16K-byte,  
RAM 640/512-byte on-chip and 352 × 9-bit OSD RAM  
8-bit 1-chip Microcontroller**

## Overview

The LC863448/40/32/28/24/20/16B are 8-bit single chip microcontrollers with the following on-chip functional blocks :

- CPU : Operable at a minimum bus cycle time of 0.424μs
  - On-chip ROM capacity  
Program ROM : 48K/40K/32K/28K/24K/20K/16K-bytes  
CGROM : 16K- bytes
  - On-chip RAM capacity : 640/512-bytes
  - OSD RAM : 352 × 9-bits
  - Closed-Caption TV controller and the on-screen display controller
  - Closed-Caption data slicer
  - Four channels × 6-bit AD Converter
  - Three channels × 7-bit PWM
  - 16-bit timer/counter, 14-bit base timer
  - IIC-bus compliant serial interface circuit (Multi-master type)
  - ROM correction function
  - 12-source 8-vectored interrupt system
  - Integrated system clock generator and display clock generator  
Only one X'tal oscillator (32.768kHz) for PLL reference is used for both generators  
TV control and the Closed Caption function
- All of the above functions are fabricated on a single chip.

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**Features**

■Read-Only Memory (ROM) : 49152 × 8-bits/40960 × 8-bits/32768 × 8-bits/  
28672 × 8-bits/24576 × 8-bits/20480 × 8-bits/  
16384 × 8-bits for program  
16128 × 8-bits for CGROM

■Random Access Memory (RAM) : 512 × 8-bits (working area) : LC863448B/40B  
384 × 8-bits (working area) : LC863432B/28B/24B/20B/16B  
128 × 8-bits (working or ROM correction function)  
352 × 9-bits (for CRT display)

**■OSD functions**

- Screen display : 36 characters × 16 lines (by software)
  - RAM : 352 words (9-bits per word)
    - Display area : 36 words × 8 lines
    - Control area : 8 words × 8 lines
  - Characters
    - Up to 252 kinds of 16 × 32 dot character fonts (4 characters including 1 test character are not programmable)
    - Each font can be divided into two parts and used as two fonts (Ex. 16 × 16 dot character font × 2)
    - At least 111 characters need to be divide between a 16 × 17 dot and 8 × 9 dot character font to display the caption fonts.
  - Various character attributes
    - Character colors : 16 colors (analog mode : 1 Vp-p output) /8 colors (digital mode)
    - Character background colors : 16 colors (analog mode : 1 Vp-p output) /8 colors (digital mode)
    - Fringe/shadow colors : 16 colors (analog mode : 1 Vp-p output) /8 colors (digital mode)
    - Full screen colors : 16 colors (analog mode : 1 Vp-p output) /8 colors (digital mode)
    - Rounding
    - Underline
    - Italic character (slanting)
  - Attribute can be changed without spacing
  - Vertical display start line number can be set for each row independently (Rows can be overlapped)
  - Horizontal display start position can be set for each row independently
  - Horizontal pitch (bit 9 to 16) <sup>\*1</sup> and vertical pitch (bit 1 to 32) can be set for each row independently
  - Different display modes can be set for each row independently
    - Caption • Text mode/OSD mode 1/OSD mode 2 (Quarter size) /Simplified graphic mode
  - Ten character sizes <sup>\*1</sup>
    - Horez. × Vert. = (1 × 1), (1 × 2), (2 × 2), (2 × 4), (0.5 × 0.5)
    - (1.5 × 1), (1.5 × 2), (3 × 2), (3 × 4), (0.75 × 0.5)
  - Shuttering and scrolling on each row
  - Simplified Graphic Display
- \*1 Note : range depends on display mode : refer to the manual for details.

**■Data Slicer (closed caption format)**

- Closed caption data and XDS data extraction
- NTSC/PAL, and extracted line can be specified

**■Bus Cycle Time/Instruction-Cycle Time**

Bus cycle time	Instruction cycle time	Clock divider	System clock oscillation	Oscillation frequency	Voltage
0.424μs	0.848μs	1/2	Internal VCO (Ref : X'tal 32.768kHz)	14.156MHz	4.5V to 5.5V
7.5μs	15.0μs	1/2	Internal RC	800kHz	4.5V to 5.5V
91.55μs	183.1μs	1/1	Crystal	32.768kHz	4.5V to 5.5V
183.1μs	366.2μs	1/2	Crystal	32.768kHz	4.5V to 5.5V

**■Ports**

- Input/Output Ports : 4 ports (23 terminals)
  - Data direction programmable in nibble units : 1 port (8 terminals)
  - (If the N-ch open drain output is selected by option, the corresponding port data can be read in output mode.)
  - Data direction programmable for each bit individually : 3 ports (15 terminals)

**■AD converter**

- 4 channels × 6-bit AD converters

**■Serial interfaces**

- IIC-bus compliant serial interface (Multi-master type)

Consists of a single built-in circuit with two I/O channels. The two data lines and two clock lines can be connected internally.

**■PWM output**

- 3 channels × 7-bit PWM

**■Timer**

- Timer 0 : 16-bit timer/counter

With 2-bit prescaler + 8-bit programmable prescaler

Mode 0 : Two 8-bit timers with a programmable prescaler

Mode 1 : 8-bit timer with a programmable prescaler + 8-bit counter

Mode 2 : 16-bit timer with a programmable prescaler

Mode 3 : 16-bit counter

The resolution of timer is 1 tCYC.

- Base timer

Generate every 500ms overflow for a clock application

(using 32.768kHz crystal oscillation for the base timer clock)

Generate every 976μs, 3.9ms, 15.6ms, 62.5ms overflow

(using 32.768kHz crystal oscillation for the base timer clock)

Clock for the base timer is selectable from 32.768kHz crystal oscillation, system clock or programmable prescaler output of Timer 0

**■Remote control receiver circuit (connected to the P73/INT3/T0IN terminal)**

- Noise rejection function
- Polarity switching

**■Watchdog timer**

External RC circuit is required

Interrupt or system reset is activated when the timer overflows

**■ROM correction function**

Max 128-bytes/2 addresses

**■Interrupts**

- 12 sources 8 vectored interrupts

1. External Interrupt INT0
2. External Interrupt INT1
3. External Interrupt INT2, Timer/counter T0L (Lower 8-bits)
4. External Interrupt INT3, base timer
5. Timer/counter T0H (Upper 8-bits)
6. Data slicer
7. Vertical synchronous signal interrupt ( $\overline{VS}$ ), horizontal line ( $\overline{HS}$ )
8. IIC, Software

- Interrupt priority control

Three interrupt priorities are supported (low, high and highest) and multi-level nesting is possible.

Low or high priority can be assigned to the interrupts from 3 to 8 listed above.

For the external interrupt INT0 and INT1, low or highest priority can be set.

### ■ Sub-routine stack level

- A maximum of 128 levels (stack is built in the internal RAM)

### ■ Multiplication/division instruction

- 16-bits  $\times$  8-bits (7 instruction cycle times)
- 16-bits  $\div$  8-bits (7 instruction cycle times)

### ■ 3 oscillation circuits

- Built-in RC oscillation circuit used for the system clock
- Built-in VCO circuit used for the system clock and OSD
- X'tal oscillation circuit used for base timer, system clock and PLL reference

### ■ Standby function

- HALT mode

The HALT mode is used to reduce the power dissipation. In this operation mode, the program execution is stopped.

This mode can be released by the interrupt request or the system reset.

- HOLD mode

The HOLD mode is used to stop the oscillations ; RC (internal), VCO, and X'tal oscillations.

This mode can be released by the following conditions.

- Pull the reset terminal (RES) to low level.
- Feed the selected level to either P70/INT0 or P71/INT1.

### ■ Package

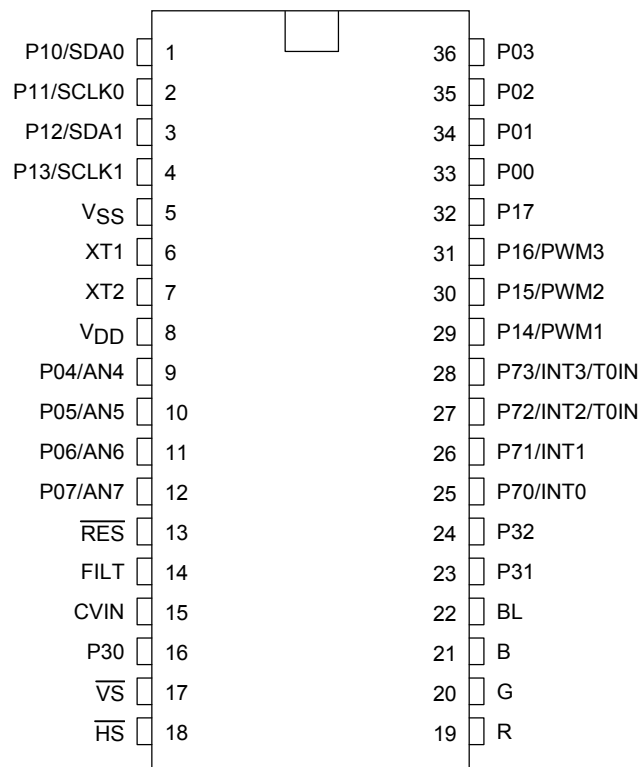
- MFP36S
- DIP36S

### ■ Development tools

- Flash EEPROM : LC86F3448A
- Evaluation chip : LC863096
- Emulator : EVA86000 (main) + ECB863200A (evaluation chip board)  
+ SUB863400A (sub board)  
+ POD36-CABLE (cable)  
+ POD36-DIP (for DIP36S)  
or POD36-MFP (for MFP36S)

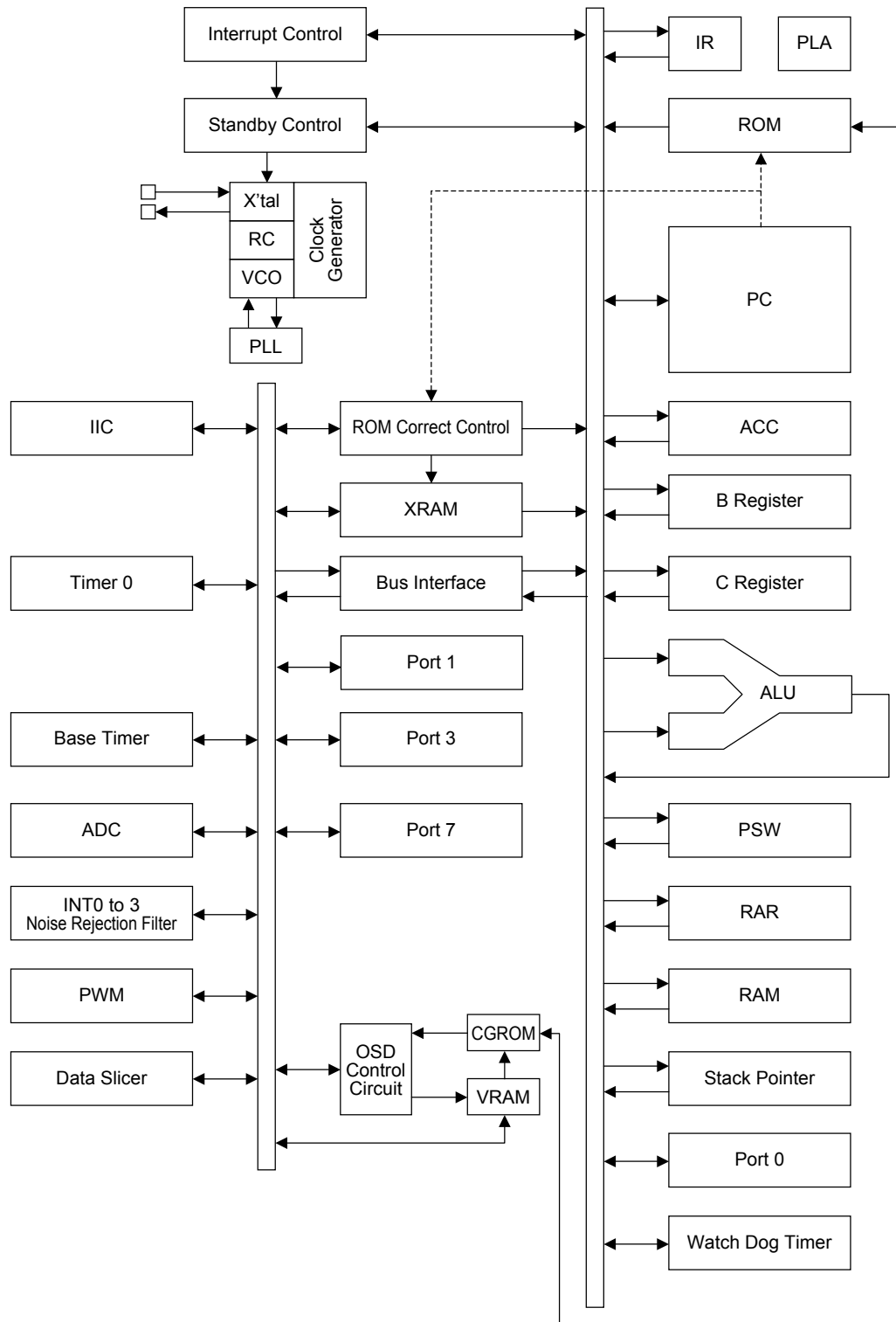


## Pin Assignment



Top view

## System Block Diagram



## Pin Description

Pin name	I/O	Function	Option																																											
VSS	-	Negative power supply																																												
XT1	I	Input terminal for crystal oscillator																																												
XT2	O	Output terminal for crystal oscillator																																												
VDD	-	Positive power supply																																												
RES	I	Reset terminal																																												
FILT	O	Filter terminal for PLL																																												
CVIN	I	Video signal input terminal																																												
VS	I	Vertical synchronization signal input terminal																																												
HS	I	Horizontal synchronization signal input terminal																																												
R	O	Red (R) output terminal of RGB image output																																												
G	O	Green (G) output terminal of RGB image output																																												
B	O	Blue (B) output terminal of RGB image output																																												
BL	O	Fast blanking control signal Switch TV image signal and caption/OSD image signal																																												
Port 0	I/O	• 8-bit input/output port Input/output can be specified in nibble unit (If the N-ch open drain output is selected by option, the corresponding port data can be read in output mode.) •Other functions AD converter input port (P04 to P07 : 4 channels)	Pull-up resistor provided/not provided Output Format CMOS/Nch-OD																																											
P00 to P07																																														
Port 1	I/O	•8-bit input/output port Input/output can be specified for each bit (Programmable pull-up resistor provided) •Other functions <table border="1"><tr><td>P10</td><td>IIC0 data I/O</td></tr><tr><td>P11</td><td>IIC0 clock output</td></tr><tr><td>P12</td><td>IIC1 data I/O</td></tr><tr><td>P13</td><td>IIC1 clock output</td></tr><tr><td>P14</td><td>PWM1 output</td></tr><tr><td>P15</td><td>PWM2 output</td></tr><tr><td>P16</td><td>PWM3 output</td></tr></table>	P10	IIC0 data I/O	P11	IIC0 clock output	P12	IIC1 data I/O	P13	IIC1 clock output	P14	PWM1 output	P15	PWM2 output	P16	PWM3 output	Output Format CMOS/Nch-OD																													
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P10 to P17																																														
Port 3	I/O	•3-bit input/output port Input/output can be specified for each bit (CMOS output/input with programmable pull-up resistor)																																												
P30 to P32																																														
Port 7	I/O	•4-bit input/output port Input or output can be specified for each bit <div><div>P70 : I/O with programmable pull-up resistor</div><div>P71 to P73 : CMOS output/input with programmable pull-up resistor</div></div> •Other function <table border="1"><tr><td>P70</td><td>INT0 input/HOLD release input/ Nch-Tr. Output for watchdog timer</td></tr><tr><td>P71</td><td>INT1 input/HOLD release input</td></tr><tr><td>P72</td><td>INT2 input/Timer 0 event input</td></tr><tr><td>P73</td><td>INT3 input (noise rejection filter connected) /Timer 0 event input</td></tr></table> Interrupt receiver format, vector addresses <table><tr><td></td><td>rising</td><td>falling</td><td>rising/ falling</td><td>H level</td><td>L level</td><td>vector</td></tr><tr><td>INT0</td><td>enable</td><td>enable</td><td>disable</td><td>enable</td><td>enable</td><td>03H</td></tr><tr><td>INT1</td><td>enable</td><td>enable</td><td>disable</td><td>enable</td><td>enable</td><td>0BH</td></tr><tr><td>INT2</td><td>enable</td><td>enable</td><td>enable</td><td>disable</td><td>disable</td><td>13H</td></tr><tr><td>INT3</td><td>enable</td><td>enable</td><td>enable</td><td>disable</td><td>disable</td><td>1BH</td></tr></table>	P70	INT0 input/HOLD release input/ Nch-Tr. Output for watchdog timer	P71	INT1 input/HOLD release input	P72	INT2 input/Timer 0 event input	P73	INT3 input (noise rejection filter connected) /Timer 0 event input		rising	falling	rising/ falling	H level	L level	vector	INT0	enable	enable	disable	enable	enable	03H	INT1	enable	enable	disable	enable	enable	0BH	INT2	enable	enable	enable	disable	disable	13H	INT3	enable	enable	enable	disable	disable	1BH	
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P71 to P73																																														

Note : A capacitor of at least 10μF must be inserted between V<sub>DD</sub> and V<sub>SS</sub> when using this IC.

Continued on next page.



## LC863448B/40B/32B/28B/24B/20B/16B

Continued from preceding page.

- Output form and existence of pull-up resistor for all ports can be specified for each bit.
- Programmable pull-up resistor is always connected regardless of port option, CMOS or N-ch open drain output in port 1.
- Port status in reset

Terminal	I/O	Pull-up resistor status at selecting CMOS output option
Port 0	I	Pull-up resistor OFF, ON after reset release
Port 1	I	Programmable pull-up resistor OFF

### Absolute Maximum Ratings / Ta = 25°C, VSS = 0V

Parameter		Symbol	Pins	Conditions	V <sub>DD</sub> [V]	Limits			
						min	typ	max	unit
Supply voltage		V <sub>DD</sub> max	V <sub>DD</sub>			-0.3		+7.0	V
Input voltage		V <sub>I</sub> (1)	RES, HS, VS, CVIN			-0.3		V <sub>DD</sub> +0.3	
Output voltage		V <sub>O</sub> (1)	R, G, B, BL, FILT			-0.3		V <sub>DD</sub> +0.3	
Input/output voltage		V <sub>IO</sub>	Ports 0, 1, 3, 7			-0.3		V <sub>DD</sub> +0.3	
High level output current	Peak output current	IOPH(1)	Ports 0, 1, 3, 7	• CMOS output • For each pin.		-4			mA
		IOPH(2)	R, G, B, BL	• CMOS output • For each pin.		-5			
	Total output current	ΣIOAH(1)	Ports 0, 1	The total of all pins.		-20			
		ΣIOAH(2)	Ports 3, 7	The total of all pins.		-10			
		ΣIOAH(3)	R, G, B, BL	The total of all pins.		-12			
Low level output current	Peak output current	IOPL(1)	Ports 0, 1, 3	For each pin.				20	
		IOPL(2)	Port 7	For each pin.				15	
		IOPL(3)	R, G, B, BL	For each pin.				5	
	Total output current	ΣIOAL(1)	Ports 0, 1	The total of all pins.				40	
		ΣIOAL(2)	Ports 3, 7	The total of all pins.				20	
		ΣIOAL(3)	R, G, B, BL	The total of all pins.				12	
Maximum power dissipation		Pd max	MFP36S	Ta = -10 to +70°C				340	mW
		DIP36S	500						
Operating temperature range		Topr				-10		+70	°C
Storage temperature range		Tstg				-55		+125	

### Recommended Operating Range / Ta = -10°C to +70°C, VSS = 0V

Parameter		Symbol	Pins	Conditions	Limits			
					VDD [V]	min	typ	max
Operating supply voltage range		VDD(1)	VDD	0.844μs ≤ tCYC ≤ 0.852μs		4.5		5.5
		VDD(2)		4μs ≤ tCYC ≤ 400μs		4.5		5.5
Hold voltage		VHD	VDD	RAMs and the registers data are kept in HOLD mode.		2.0		5.5
High level input voltage	VIH(1)	Port 0	Output disable	4.5 to 5.5	0.6VDD			VDD
	VIH(2)	• Ports 1, 3 (Schmitt) • Port 7 (Schmitt) port input/interrupt • HS, VS, RES (Schmitt)	Output disable	4.5 to 5.5	0.75VDD			VDD
	VIH(3)	Port 70 Watchdog timer input	Output disable	4.5 to 5.5	VDD-0.5			VDD

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# LC863448B/40B/32B/28B/24B/20B/16B

Continued from preceding page.

Parameter	Symbol	Pins	Conditions	V <sub>DD</sub> [V]	Limits			
					min	typ	max	unit
Low level input voltage	V <sub>IL</sub> (1)	Port 0	Output disable	4.5 to 5.5	V <sub>SS</sub>		0.2V <sub>DD</sub>	V
	V <sub>IL</sub> (2)	• Ports 1, 3 (Schmitt) • Port 7 (Schmitt) port input/interrupt • HS, VS, RES (Schmitt)	Output disable	4.5 to 5.5	V <sub>SS</sub>		0.25V <sub>DD</sub>	
	V <sub>IL</sub> (3)	Port 70 Watchdog timer input	Output disable	4.5 to 5.5	V <sub>SS</sub>		0.6V <sub>DD</sub>	
CVIN	VCVIN	CVIN		5.0	0.7Vp-p	1Vp-p	1.4Vp-p	Vp-p*
Operation cycle time	tCYC(1)		• All functions operating	4.5 to 5.5	0.844	0.848	0.852	μs
	tCYC(2)		• OSD and Data slicer are not operating	4.5 to 5.5	0.844		400	
Oscillation frequency range	FmRC		Internal RC oscillation	4.5 to 5.5	0.4	0.8	3.0	MHz

\* Vp-p : Peak-to-peak voltage

## Electrical Characteristics / Ta = -10°C to +70°C, V<sub>SS</sub> = 0V

Parameter	Symbol	Pins	Conditions	V <sub>DD</sub> [V]	Limits			
					min	typ	max	unit
High level input current	I <sub>IH</sub> (1)	Ports 0, 1, 3, 7	• Output disable • Pull-up MOS Tr. OFF • V <sub>IN</sub> = V <sub>DD</sub> (Including the off-leak current of the output Tr.)	4.5 to 5.5			1	μA
	I <sub>IH</sub> (2)	• $\overline{\text{RES}}$ • $\overline{\text{HS}}$ , $\overline{\text{VS}}$	• V <sub>IN</sub> = V <sub>DD</sub>	4.5 to 5.5			1	
Low level input current	I <sub>IL</sub> (1)	Ports 0, 1, 3, 7	• Output disable • Pull-up MOS Tr. OFF • V <sub>IN</sub> = V <sub>SS</sub> (Including the off-leak current of the output Tr.)	4.5 to 5.5	-1			μA
	I <sub>IL</sub> (2)	• $\overline{\text{RES}}$ • $\overline{\text{HS}}$ , $\overline{\text{VS}}$	V <sub>IN</sub> = V <sub>SS</sub>	4.5 to 5.5	-1			
High level output voltage	V <sub>OH</sub> (1)	• CMOS output of ports 0, 1, 3, 71 to 73	I <sub>OH</sub> = -1.0mA	4.5 to 5.5	V <sub>DD</sub> -1			V
	V <sub>OH</sub> (2)	R, G, B, BL	I <sub>OH</sub> = -0.1mA R, G, B : digital mode	4.5 to 5.5	V <sub>DD</sub> -0.5			
Low level output voltage	V <sub>OL</sub> (1)	Ports 0, 1, 3, 71 to 73	I <sub>OL</sub> = 10mA	4.5 to 5.5			1.5	V
	V <sub>OL</sub> (2)	Ports 0, 3, 71 to 73	I <sub>OL</sub> = 1.6mA	4.5 to 5.5			0.4	
	V <sub>OL</sub> (3)	• R, G, B, BL • Port 1	I <sub>OL</sub> = 3.0mA R, G, B : digital mode	4.5 to 5.5			0.4	
	V <sub>OL</sub> (4)	Port 70	I <sub>OL</sub> = 1mA	4.5 to 5.5			0.4	
Pull-up MOS Tr. resistance	Rpu	• Ports 0, 1, 3, 7	V <sub>OH</sub> = 0.9V <sub>DD</sub>	4.5 to 5.5	13	38	80	kΩ
Bus terminal short circuit resistance (SCL0 to SCL1, SDA0 to SDA1)	RBS	• P10 to P12 • P11 to P13		4.5 to 5.5		130	300	Ω
Hysteresis voltage	VHIS	• Ports 1, 3, 7 • $\overline{\text{RES}}$ • $\overline{\text{HS}}$ , $\overline{\text{VS}}$	Output disable	4.5 to 5.5		0.1V <sub>DD</sub>		V
Input clump voltage	VCLMP	CVIN		5.0	2.3	2.5	2.7	
Pin capacitance	CP	All pins	• f = 1MHz • Every other terminals are connected to V <sub>SS</sub> . • Ta = 25°C	4.5 to 5.5		10		pF

# LC863448B/40B/32B/28B/24B/20B/16B

## IIC Input/Output Conditions / Ta = -10°C to +70°C, VSS = 0V

Parameter	Symbol	Standard		High speed		unit
		min	max	min	max	
SCL Frequency	fSCL	0	100	0	400	kHz
BUS free time between stop to start	tBUF	4.7	-	1.3	-	μs
HOLD time of start, restart condition	tHD ; STA	4.0	-	0.6	-	μs
L time of SCL	tLOW	4.7	-	1.3	-	μs
H time of SCL	tHIGH	4.0	-	0.6	-	μs
Set-up time of restart condition	tSU ; STA	4.7	-	0.6	-	μs
HOLD time of SDA	tHD ; DAT	0	-	0	0.9	μs
Set-up time of SDA	tSU ; DAT	250	-	100	-	ns
Rising time of SDA, SCL	tR	-	1000	20 + 0.1Cb	300	ns
Falling time of SDA, SCL	tF	-	300	20 + 0.1Cb	300	ns
Set-up time of stop condition	tSU ; STO	4.0	-	0.6	-	μs

Refer to figure 8

Note : Cb : Total capacitance of all BUS (unit : pF)

## Pulse Input Conditions / Ta = -10°C to +70°C, VSS = 0V

Parameter	Symbol	Pins	Conditions	VDD[V]	Limits			unit
					min	typ	max	
High/low level pulse width	tPIH(1) tPIL(1)	• INT0, INT1 • INT2/T0IN	• Interrupt acceptable • Timer 0-countable	4.5 to 5.5	1			tCYC
	tPIH(2) tPIL(2)	INT3/T0IN (1 tCYC is selected for noise rejection clock.)	• Interrupt acceptable • Timer 0-countable	4.5 to 5.5	2			
	tPIH(3) tPIL(3)	INT3/T0IN (16 tCYC is selected for noise rejection clock.)	• Interrupt acceptable • Timer 0-countable	4.5 to 5.5	32			
	tPIH(4) tPIL(4)	INT3/T0IN (64 tCYC is selected for noise rejection clock.)	• Interrupt acceptable • Timer 0-countable	4.5 to 5.5	128			
	tPIL(5)	RES	Reset acceptable	4.5 to 5.5	200			μs
	tPIH(6) tPIL(6)	HS, VS	• Display position controllable (Note) • The active edge of HS and VS must be apart at least 1 tCYC. • Refer to figure 4.	4.5 to 5.5	3			
Rising/falling time	tTHL tTLH	HS	Refer to figure 4.	4.5 to 5.5			500	ns

## AD Converter Characteristics / Ta = -10°C to +70°C, VSS = 0V

Parameter	Symbol	Pins	Conditions	VDD [V]	Limits			unit
					min	typ	max	
Resolution	N			4.5 to 5.5		6		bit
Absolute precision	ET		(Note)				±1	LSB
Conversion time	tCAD	Vref selection to conversion finish	1-bit conversion time = 2 × tCYC			1.69		μs
Analog input voltage range	VAIN	AN4 to AN7			VSS		VDD	V
Analog port input current	IAINH		VAIN = VDD				1	μA
	IAINL		VAIN = VSS		-1			

Note : Absolute precision does not include quantizing error (1/2LSB).

# LC863448B/40B/32B/28B/24B/20B/16B

## Analog Mode RGB Characteristics / Ta = -10°C to +70°C, VSS = 0V

Parameter	Symbol	Pins	Conditions	VDD [V]	Limits			
					min	typ	max	unit
Analog output voltage		R. G. B Analog output mode	Low level output	5.0	0.45	0.5	0.55	V
			Intensity output		0.90	1.0	1.10	
			Hi level output		1.35	1.5	1.65	
Time setting		R. G. B	70% 10pf load				50	ns

## Sample Current Dissipation Characteristics / Ta = -10°C to +70°C, VSS = 0V

The sample current dissipation characteristics are the measurement result of SANYO provided evaluation board when the recommended circuit parameters shown in the sample oscillation circuit characteristics are used externally. The currents through the output transistors and the pull-up MOS transistors are ignored.

Parameter	Symbol	Pins	Conditions	VDD [V]	Limits			
					min	typ	max	unit
Current dissipation during basic operation (Note 3)	IDDOP(1)	VDD	<ul style="list-style-type: none"> <li>FmX'tal = 32.768kHz</li> <li>X'tal oscillation</li> <li>System clock : VCO</li> <li>VCO for OSD operating</li> <li>OSD is Digital mode</li> <li>Internal RC oscillation stops</li> </ul>	4.5 to 5.5		14	28	mA
	IDDOP(2)	VDD	<ul style="list-style-type: none"> <li>FmX'tal = 32.768kHz</li> <li>X'tal oscillation</li> <li>System clock : VCO</li> <li>VCO for OSD operating</li> <li>OSD is Analog mode</li> <li>Internal RC oscillation stops</li> </ul>	4.5 to 5.5		22	40	
	IDDOP(3)	VDD	<ul style="list-style-type: none"> <li>FmX'tal = 32.768kHz</li> <li>X'tal oscillation</li> <li>System clock : X'tal (Instruction cycle time : 366.2μs)</li> <li>VCO for system VCO for OSD, internal RC oscillation stop</li> <li>Data slicer, AD converters stop</li> </ul>	4.5 to 5.5		50	300	μA
Current dissipation in HALT mode (Note 3)	IDDHALT(1)	VDD	<ul style="list-style-type: none"> <li>HALT mode</li> <li>FmX'tal = 32.768kHz</li> <li>X'tal oscillation</li> <li>System clock : VCO</li> <li>VCO for OSD stops</li> <li>Internal RC oscillation stops</li> </ul>	4.5 to 5.5		4	10	mA
	IDDHALT(2)	VDD	<ul style="list-style-type: none"> <li>HALT mode</li> <li>FmX'tal = 32.768kHz</li> <li>X'tal oscillation</li> <li>VCO for system stops</li> <li>VCO for OSD stops</li> <li>System clock : Internal RC</li> </ul>	4.5 to 5.5		300	1000	
	IDDHALT(3)	VDD	<ul style="list-style-type: none"> <li>HALT mode</li> <li>FmX'tal = 32.768kHz</li> <li>X'tal oscillation</li> <li>VCO for system stops</li> <li>VCO for OSD stops</li> <li>System clock : X'tal (Instruction cycle time : 366.2μs)</li> </ul>	4.5 to 5.5		35	200	μA
Current dissipation in HOLD mode (Note 3)	IDDHOLD	VDD	<ul style="list-style-type: none"> <li>HOLD mode</li> <li>All oscillation stops.</li> </ul>	4.5 to 5.5		0.05	20	μA

Note 3 : The currents through the output transistors and the pull-up MOS transistors are ignored.

## Recommended Oscillation Circuit and Sample Characteristics

The sample oscillation circuit characteristics in the table below is based on the following conditions :

- Recommended circuit parameters are verified by an oscillator manufacturer using a SANYO provided oscillation evaluation board.
- Sample characteristics are the result of the evaluation with the recommended circuit parameters connected externally.

Recommended oscillation circuit and sample characteristics (Ta = -10 to +70°C)

Frequency	Manufacturer	Oscillator	Recommended circuit parameters				Operating supply voltage range	Oscillation stabilizing time		Notes
			C1	C2	Rf	Rd		typ	max	
32.768kHz	Seiko Epson	C-002RX	18pF	18pF	OPEN	390kΩ	4.5 to 5.5V	1.00S	1.50S	

Notes : The oscillation stabilizing time period is the time until the VCO oscillation for the internal system becomes stable after the following conditions. (Refer to Figure 2.)

- The  $V_{DD}$  becomes higher than the minimum operating voltage after the power is supplied.
- The HOLD mode is released.

The sample oscillation circuit characteristics may differ applications. For further assistance, please contact with oscillator manufacturer with the following notes in your mind.

- Since the oscillation frequency precision is affected by wiring capacity of the application board, etc., adjust the oscillation frequency on the production board.
- The above oscillation frequency and the operating supply voltage range are based on the operating temperature of -10°C to +70°C. For the use with the temperature outside of the range herein, or in the applications requiring high reliability such as car products, please consult with oscillator manufacturer.
- When using the oscillator which is not shown in the sample oscillation circuit characteristics, please consult with SANYO sales personnel.

Since the oscillation circuit characteristics are affected by the noise or wiring capacity because the circuit is designed with low gain in order to reduce the power dissipation, refer to the following notices.

- The distance between the clock I/O terminal (XT1 terminal XT2 terminal) and external parts should be as short as possible.
- The capacitors'  $V_{SS}$  should be allocated close to the microcontroller's GND terminal and be away from other GND.
- The signal lines with rapid state changes or with large current should be allocated away from the oscillation circuit.

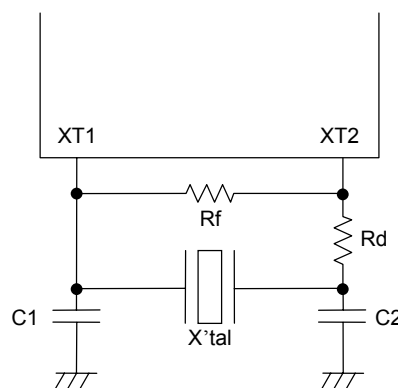
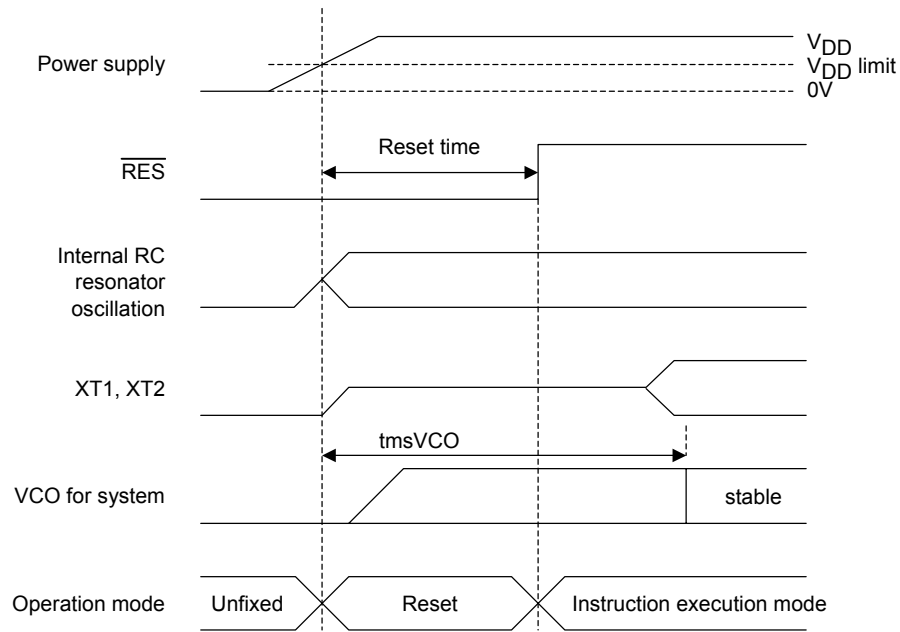
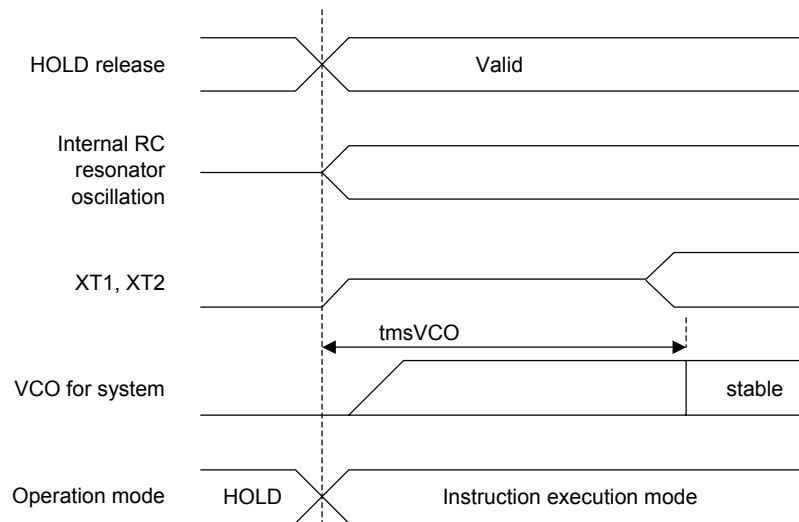


Figure 1 Recommended oscillation circuit



<Reset time and oscillation stabilizing time>



<HOLD release signal and oscillation stabilizing time>

Figure 2 Oscillation stabilizing time

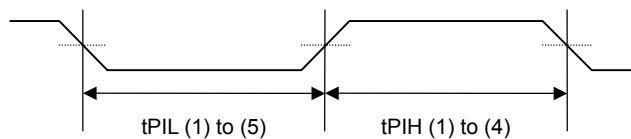


Figure 3 Pulse input timing condition - 1

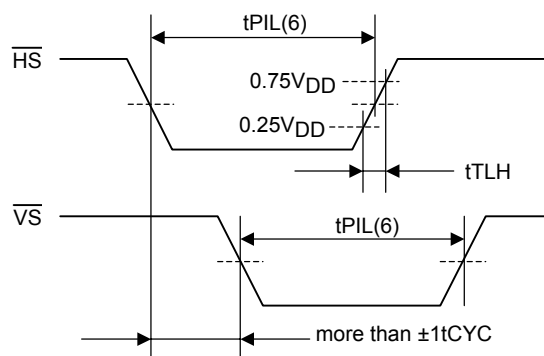


Figure 4 Pulse input timing condition - 2

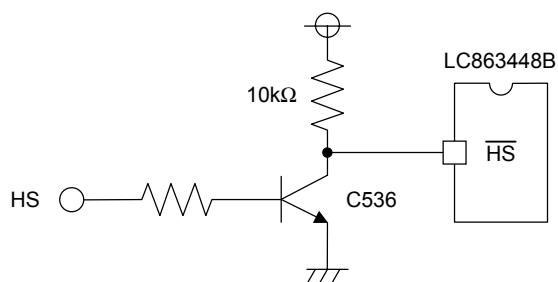
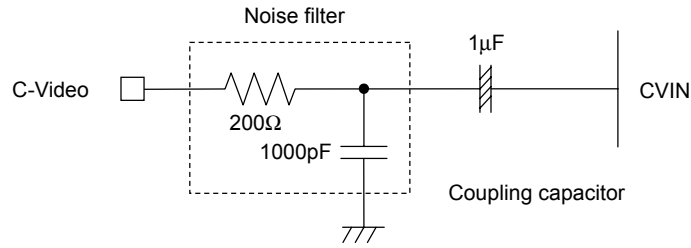


Figure 5 Recommended Interface circuit



Output impedance of C-Video before Noise filter should be less than 100Ω.

Figure 6 CVIN recommended circuit

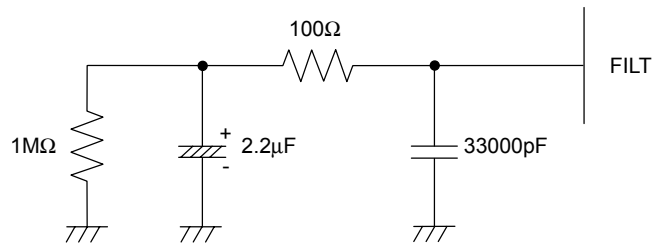
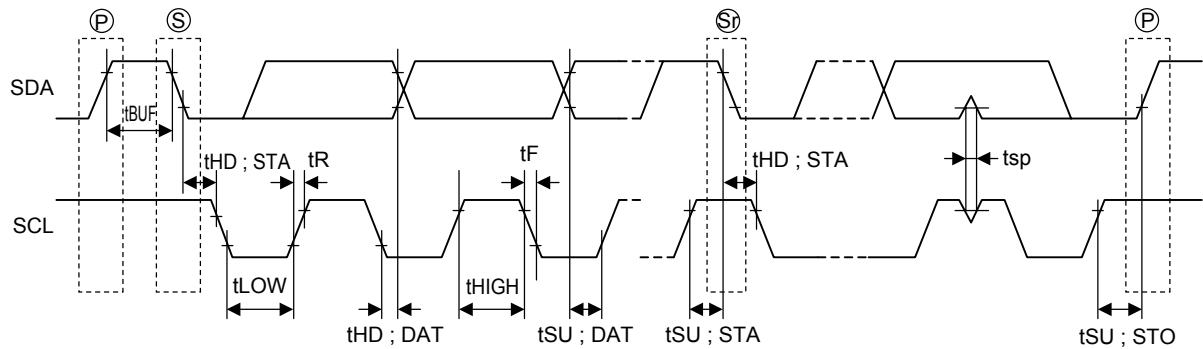


Figure 7 FILT recommended circuit

Note : Place FILT parts on board as close to the microcontroller as possible.



S : start condition  
P : stop condition  
Sr : restart condition

tsp : Spike suppression

Standard mode : not exist  
High speed mode : less than 50ns

Figure 8 IIC timing



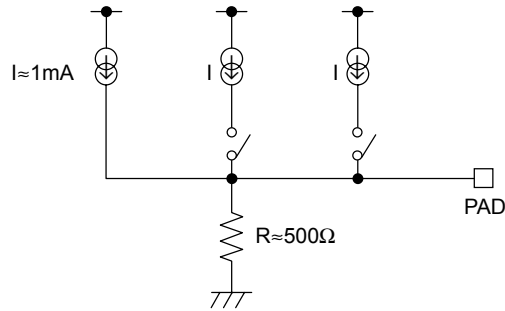


Figure 9 R. G. B. analog output equivalent circuit

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